

STARPOWER

SEMICONDUCTOR

IGBT

GD800HFY120C6H

1200V/800A 2 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as hybrid and electric vehicle.

Features

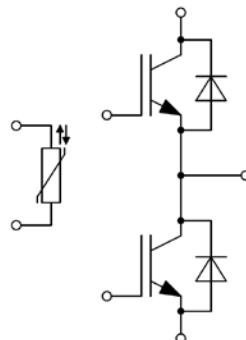
- Low $V_{CE(sat)}$ Trench IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175 $^{\circ}$ C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Si3N4 substrate for low thermal resistance
- Isolated copper baseplate using DBC technology



Typical Applications

- Hybrid and electric vehicle
- Inverter for motor drive
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current	800	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	1600	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	TBD	W

Diode

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	800	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	1600	A

Module

Symbol	Description	Value	Unit
T_{jmax}	Maximum Junction Temperature	175	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}, t=1\text{min}$	2500	V

IGBT Characteristics $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=800\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.95	2.40	V	
		$I_C=800\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.30			
		$I_C=800\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		2.40			
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=15.0\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.2	6.0	6.8	V	
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA	
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA	
R_{Gint}	Internal Gate Resistance			1.2		Ω	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		38.0		nF	
C_{res}	Reverse Transfer Capacitance				2.15		nF
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=800\text{A}, R_G=1.5\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		173		ns	
t_r	Rise Time			84		ns	
$t_{d(off)}$	Turn-Off Delay Time			568		ns	
t_f	Fall Time			195		ns	
E_{on}	Turn-On Switching Loss			23.2		mJ	
E_{off}	Turn-Off Switching Loss			89.2		mJ	
$t_{d(on)}$	Turn-On Delay Time		$V_{CC}=600\text{V}, I_C=800\text{A}, R_G=1.5\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		197		ns
t_r	Rise Time				92		ns
$t_{d(off)}$	Turn-Off Delay Time				613		ns
t_f	Fall Time				316		ns
E_{on}	Turn-On Switching Loss			49.5		mJ	
E_{off}	Turn-Off Switching Loss			115		mJ	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=800\text{A}, R_G=1.5\Omega, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$			207		ns
t_r	Rise Time				94		ns
$t_{d(off)}$	Turn-Off Delay Time			624		ns	
t_f	Fall Time			351		ns	
E_{on}	Turn-On Switching Loss			57.8		mJ	
E_{off}	Turn-Off Switching Loss			120		mJ	
I_{SC}	SC Data		$t_p \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=800\text{V}, V_{CEM} \leq 1200\text{V}$		2400		A

Diode Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=800\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.81	2.26	V
		$I_F=800\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$		1.86		
		$I_F=800\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		1.86		
Q_r	Recovered Charge			42		μC
I_{RM}	Peak Reverse Recovery Current	$V_{CC}=600\text{V}, I_F=800\text{A},$ $-di/dt=4000\text{A}/\mu\text{s}, V_{GE}=-15\text{V},$ $T_j=25^\circ\text{C}$		359		A
E_{rec}	Reverse Recovery Energy			25.6		mJ
Q_r	Recovered Charge			94		μC
I_{RM}	Peak Reverse Recovery Current	$V_{CC}=600\text{V}, I_F=800\text{A},$ $-di/dt=4000\text{A}/\mu\text{s}, V_{GE}=-15\text{V},$ $T_j=125^\circ\text{C}$		479		A
E_{rec}	Reverse Recovery Energy			51.8		mJ
Q_r	Recovered Charge			106		μC
I_{RM}	Peak Reverse Recovery Current	$V_{CC}=600\text{V}, I_F=800\text{A},$ $-di/dt=4000\text{A}/\mu\text{s}, V_{GE}=-15\text{V},$ $T_j=150^\circ\text{C}$		506		A
E_{rec}	Reverse Recovery Energy			57.2		mJ

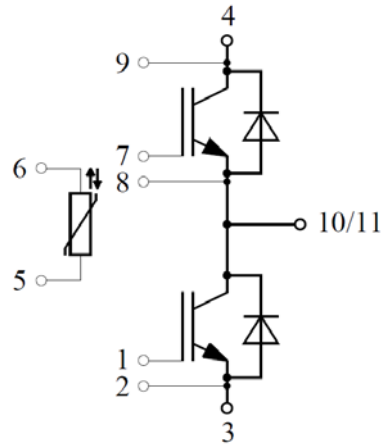
NTC Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Rated Resistance			5.0		k Ω
$\Delta R/R$	Deviation of R_{100}	$T_C=100^\circ\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K
$B_{25/80}$	B-value	$R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$		3411		K
$B_{25/100}$	B-value	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$		3433		K

Module Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

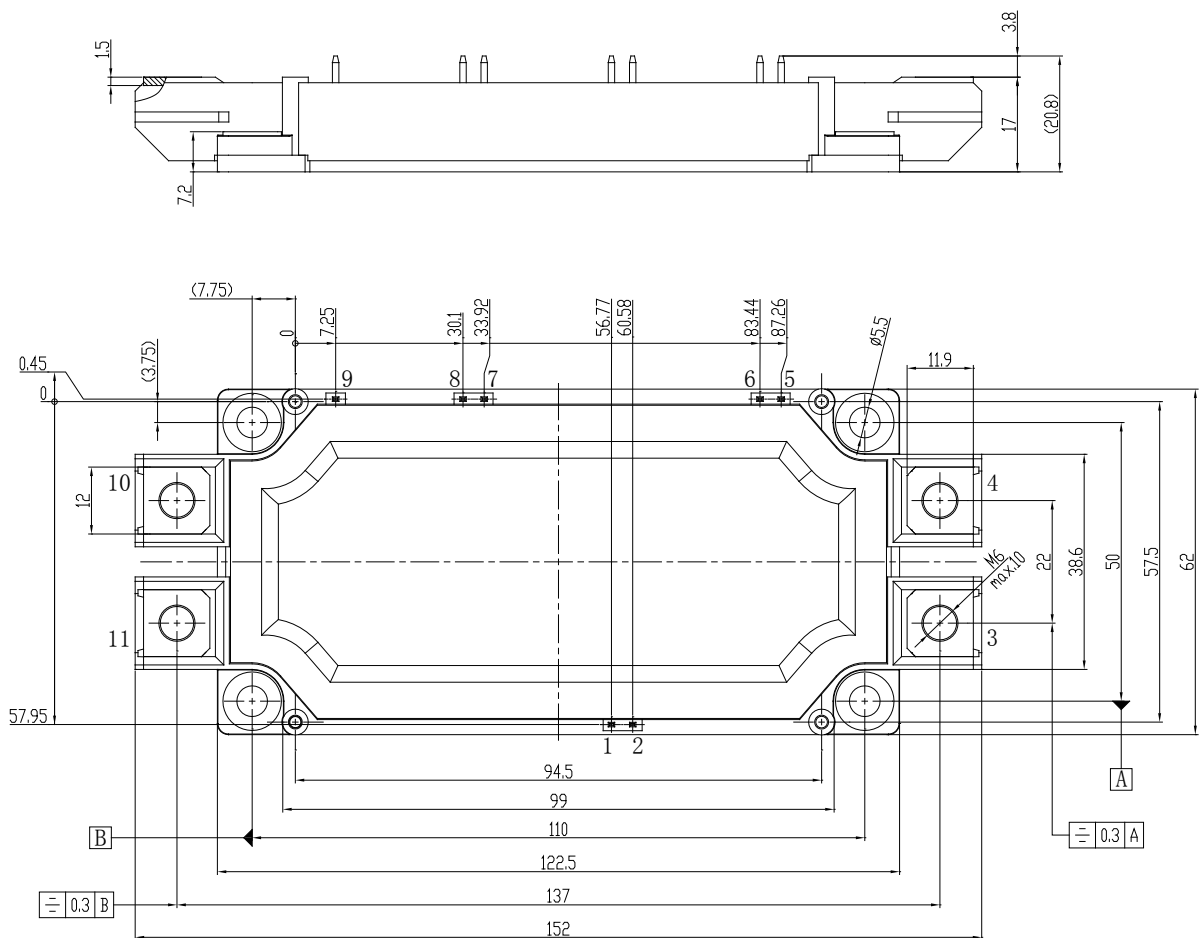
Symbol	Parameter	Min.	Typ.	Max.	Unit
R_{thJC}	Junction-to-Case (per IGBT)			0.029	K/W
	Junction-to-Case (per Diode)			0.048	
R_{thCH}	Case-to-Heatsink (per IGBT)		0.029		K/W
	Case-to-Heatsink (per Diode)		0.048		
	Case-to-Heatsink (per Module)		0.009		
M	Terminal Connection Torque, Screw M6	3.0		6.0	N.m
	Mounting Torque, Screw M5	3.0		6.0	
G	Weight of Module		350		g

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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